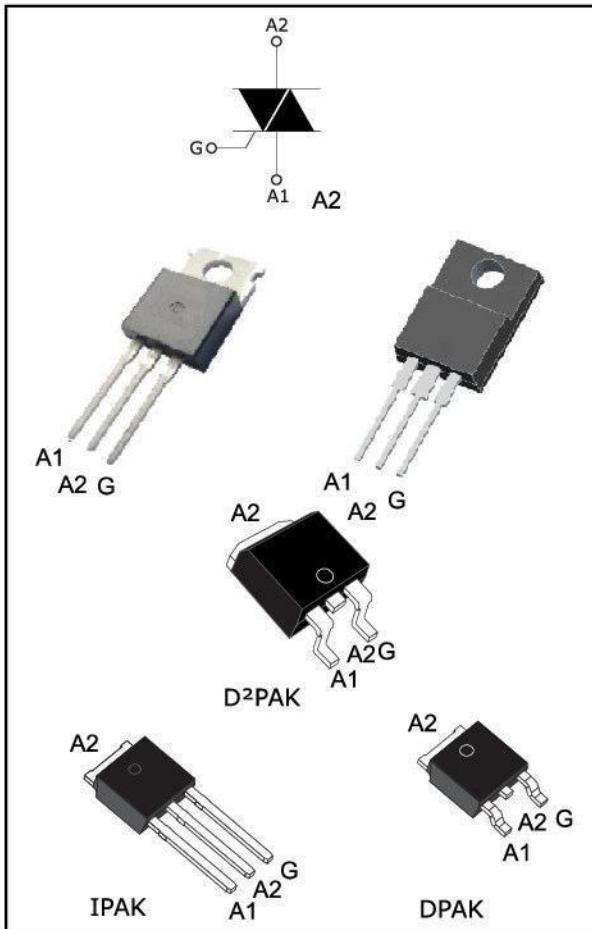




BTB08/BTA08



Features

- On-state rms current, $I_{T(RMS)}$ 8 A
- Repetitive peak off-state voltage, V_{DRM} / V_{RRM} 600 V to 800 V
- Triggering gate current, $I_{GT(Q1)}$ 5 to 50 mA

Description

Available either in through-hole and surface-mount packages, these devices are suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits or for phase control operation in light dimmers and motor speed controllers, etc.

The Snubberless versions (BTA, BTB08_xxxxW and T8 series) are specially recommended for use on inductive loads, thanks to their high commutation performance.

Logic level versions are designed to interface directly with low power drivers such as Microcontrollers.

Characteristics

Characteristics

Table 1: Absolute maximum ratings ($T_j = 25^\circ\text{C}$ unless otherwise stated)

| Symbol | Parameter | | | | Value | Unit |
|---------------------|--|------------------------|--|---------------------------|-------------|------------------------|
| $I_{T(\text{RMS})}$ | RMS on-state current (full sine wave) | | IPAK, DPAK, TO-220AB, D ² PAK | $T_c = 110^\circ\text{C}$ | 8 | A |
| | | | TO-220ABIns. | $T_c = 100^\circ\text{C}$ | | |
| I_{TSM} | Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C) | | $f = 50 \text{ Hz}$ | $t = 20 \text{ ms}$ | 80 | A |
| | | | $f = 60 \text{ Hz}$ | $t_p = 16.7 \text{ ms}$ | 84 | |
| I^2t | I^2t value for fusing | | | $t_p = 10 \text{ ms}$ | 36 | A^2s |
| dI/dt | Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100 \text{ ns}$ | $f = 120 \text{ Hz}$ | | $T_j = 125^\circ\text{C}$ | 50 | $\text{A}/\mu\text{s}$ |
| I_{GM} | Peak gate current | $t_p = 20 \mu\text{s}$ | | $T_j = 125^\circ\text{C}$ | 4 | A |
| $P_{G(AV)}$ | Average gate power dissipation | | | $T_j = 125^\circ\text{C}$ | 1 | W |
| T_{stg} | Storage junction temperature range | | | | -40 to +150 | °C |
| T_j | Operating junction temperature range | | | | -40 to +125 | °C |

Table 2: Electrical characteristics ($T_j = 25^\circ\text{C}$, unless otherwise specified) Snubberless and logic level (3 quadrants)

| Symbol | Parameter | Quadrant | | T8 | | | BTA08/BTB08 | | | Unit | |
|-------------|---|--------------|------|-----|------|-----|-------------|-----|------|------|----|
| | | | | 10 | 35 | 50 | TW | SW | CW | | |
| $I_{GT(1)}$ | $V_D = 12 \text{ V}$, $R_L = 100\Omega$ | I - II - III | Max. | 10 | 35 | 50 | 5 | 10 | 35 | 50 | mA |
| V_{GT} | | I - II - III | Max. | 1.2 | | | | | | V | |
| V_{GD} | $V_D = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$, $T_j = 125^\circ\text{C}$ | I - II - III | Min. | 0.2 | | | | | | V | |
| $I_H(2)$ | $I_T = 100 \text{ mA}$ | | Max. | 15 | 35 | 50 | 10 | 15 | 35 | 50 | mA |
| I_L | $I_G = 1.2 \times I_{GT}$ | I - III | Max. | 25 | 50 | 70 | 10 | 25 | 50 | 70 | mA |
| | | II | Max. | 30 | 60 | 80 | 15 | 30 | 60 | 80 | |
| dV/dt | $V_D = 67\% V_{DRM}$, gate open, $T_j = 125^\circ\text{C}$ | Max. | 40 | 400 | 1000 | 20 | 40 | 400 | 1000 | V/μs | |
| $(dI/dt)c$ | $(dV/dt)c = 0.1 \text{ V}/\mu\text{s}$, $T_j = 125^\circ\text{C}$ | Min. | 5.4 | | | 3.5 | 5.4 | | | A/ms | |
| | $(dV/dt)c = 10 \text{ V}/\mu\text{s}$, $T_j = 125^\circ\text{C}$ | Min. | 2.8 | | | 1.5 | 2.98 | | | | |
| | Without snubber, $T_j = 125^\circ\text{C}$ | Min. | | 4.5 | 7 | | | 4.5 | 7 | | |

Notes:

(¹) Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.

(²) For both polarities of A2 referenced to A1

Characteristics

Table 3: Standard (4 quadrants)

| Symbol | Parameter | Quadrant | BTA08/BTB08 | | Unit |
|------------------|---|--------------|-------------|-----|------------|
| | | | C | B | |
| $I_{GT}^{(1)}$ | $V_D = 12 \text{ V}, R_L = 100\Omega$ | I - II - III | Max. | 25 | 35 |
| | | IV | | 50 | 100 |
| V_{GT} | | All | Max. | 1.3 | |
| V_{GD} | $V_D = V_{DRM}, R_L = 33 \Omega, T_j = 125 \text{ }^\circ\text{C}$ | All | Min. | 0.2 | |
| $I_H^{(2)}$ | $I_T = 500 \text{ mA}$ | | Max. | 25 | 50 |
| I_L | $I_G = 1.2 I_{GT}$ | I - III - IV | Max. | 40 | 50 |
| | | II | | 80 | 100 |
| $dV/dt^{(2)}$ | $V_D = 67 \% V_{DRM}$ gate open, $T_j = 125 \text{ }^\circ\text{C}$ | | Min. | 200 | 400 |
| $(dl/dt)c^{(2)}$ | $(dl/dt)c = 5.3 \text{ A/ms}, T_j = 125 \text{ }^\circ\text{C}$ | | Min. | 5 | 10 |
| | | | | | V/ μ A |

Notes:

⁽¹⁾ Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.

⁽²⁾ For both polarities of A2 referenced to A1

Table 4: Static electrical characteristics

| Symbol | Test conditions | | | Value | Unit |
|-------------------|--|------------------------------------|------|-------|------------------|
| $V_{TM}^{(1)}$ | $I_{TM} = 11 \text{ A}, t_p = 380 \mu\text{s}$ | $T_j = 25 \text{ }^\circ\text{C}$ | Max. | 1.55 | V |
| $V_{TO}^{(1)}$ | threshold on-state voltage | $T_j = 125 \text{ }^\circ\text{C}$ | Max. | 0.85 | V |
| $R_D^{(1)}$ | Dynamic resistance | $T_j = 125 \text{ }^\circ\text{C}$ | Max. | 50 | $\text{m}\Omega$ |
| $I_{DRM} I_{RRM}$ | $V_{DRM} = V_{RRM}$ | $T_j = 25 \text{ }^\circ\text{C}$ | Max. | 5 | μA |
| | | $T_j = 125 \text{ }^\circ\text{C}$ | Max. | 1 | mA |

Notes:

⁽¹⁾ For both polarities of A2 referenced to A1

Table 5: Thermal resistance

| Symbol | Parameter | | | Value | Unit |
|---------------|---|----------------------------|--------------------------------|-------|---------------------------|
| $R_{th(j-c)}$ | Max. junction to case thermal resistance (AC) | | IPAK / D2PAK / DPAK / TO-220AB | 1.6 | $^\circ\text{C}/\text{W}$ |
| | TO-220AB Insulated | | | 2.5 | |
| $R_{th(j-a)}$ | Junction to ambient | $S^{(1)} = 1 \text{ cm}^2$ | D ² PAK | 45 | $^\circ\text{C}/\text{W}$ |
| | | $S = 1 \text{ cm}^2$ | DPAK | 70 | |
| | Junction to ambient | | TO-220AB / TO-220AB Insulated | 60 | |
| | | | IPAK | 100 | |

Notes:

⁽¹⁾ S = Copper surface under tab

Characteristics

Characteristics (curves)

Figure 1: Maximum power dissipation versus on-state RMS current (full cycle)

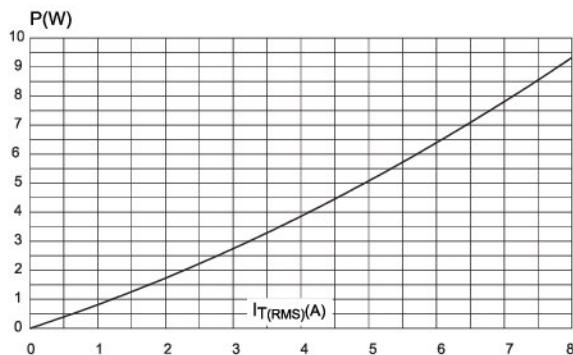


Figure 2: RMS on-state current versus temperature (full cycle)

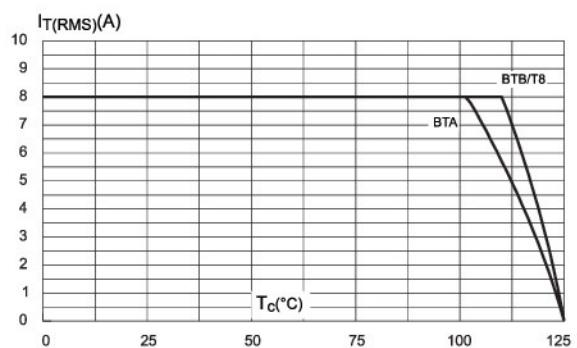


Figure 3: RMS on-state current versus ambient temperature (full cycle)

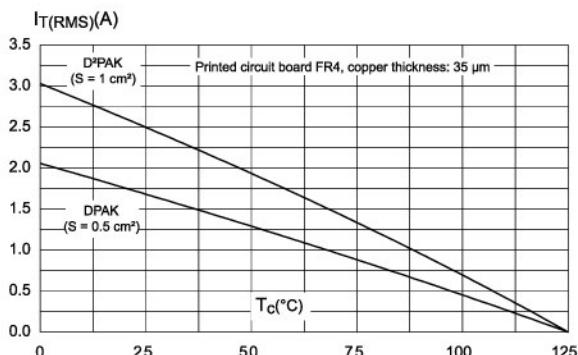


Figure 4: Relative variation of thermal impedance versus pulse duration

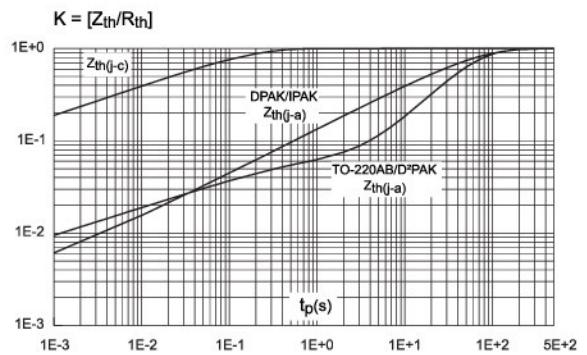


Figure 5: On-state characteristics (maximum values)

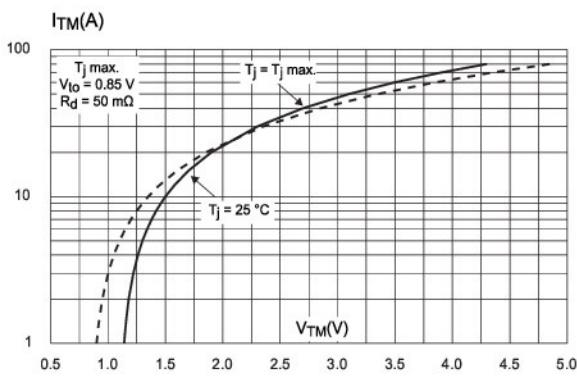


Figure 6: Surge peak on-state current versus number of cycles

